

**CDM3-800**

**SURFACE MOUNT SILICON  
N-CHANNEL  
POWER MOSFET  
3.0 AMP, 800 VOLT**

**DPAK CASE**[www.centrasemi.com](http://www.centrasemi.com)**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CDM3-800 is a 800 volt N-Channel MOSFET designed for high voltage, fast switching applications such as Power Factor Correction (PFC), lighting and power inverters. This MOSFET combines high voltage capability with low  $r_{DS(ON)}$ , low threshold voltage, and low gate charge for optimal efficiency.

**MARKING: FULL PART NUMBER****APPLICATIONS:**

- Power Factor Correction
- Alternative energy inverters
- Solid State Lighting (SSL)

**FEATURES:**

- High voltage capability ( $V_{DS}=800V$ )
- Low gate charge ( $Q_{g(tot)}=11.3nC$  TYP)
- Low  $r_{DS(ON)}$  ( $3.8\Omega$  TYP)

**MAXIMUM RATINGS:** ( $T_C=25^\circ C$  unless otherwise noted)

	SYMBOL		UNITS
Drain-Source Voltage	$V_{DS}$	800	V
Gate-Source Voltage	$V_{GS}$	30	V
Continuous Drain Current (Steady State)	$I_D$	3.0	A
Maximum Pulsed Drain Current, $t_p=10\mu s$	$I_{DM}$	12	A
Continuous Source Current (Body Diode)	$I_S$	3.0	A
Maximum Pulsed Source Current (Body Diode)	$I_{SM}$	12	A
Single Pulse Avalanche Energy (Note 1)	$E_{AS}$	173	mJ
Power Dissipation	$P_D$	80	W
Operating and Storage Junction Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ C$
Thermal Resistance	$\theta_{JC}$	1.56	$^\circ C/W$
Thermal Resistance	$\theta_{JA}$	110	$^\circ C/W$

Note 1:  $L=30mH, I_{AS}=3.15A, V_{DD}=100V, R_G=25\Omega, \text{Initial } T_J=25^\circ C$

**ELECTRICAL CHARACTERISTICS:** ( $T_C=25^\circ C$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$I_{GSSF}, I_{GSSR}$	$V_{GS}=30V, V_{DS}=0$		10	100	nA
$I_{DSS}$	$V_{DS}=800V, V_{GS}=0$		0.08	1.0	$\mu A$
$BV_{DSS}$	$V_{GS}=0, I_D=250\mu A$	800			V
$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	3.0	4.0	V
$V_{SD}$	$V_{GS}=0, I_S=3.0A$		0.98	1.4	V
$r_{DS(ON)}$	$V_{GS}=10V, I_D=1.5A$		3.8	4.8	$\Omega$
$C_{rss}$	$V_{DS}=25V, V_{GS}=0, f=1.0MHz$		1.5		pF
$C_{iss}$	$V_{DS}=25V, V_{GS}=0, f=1.0MHz$		415		pF
$C_{oss}$	$V_{DS}=25V, V_{GS}=0, f=1.0MHz$		44		pF

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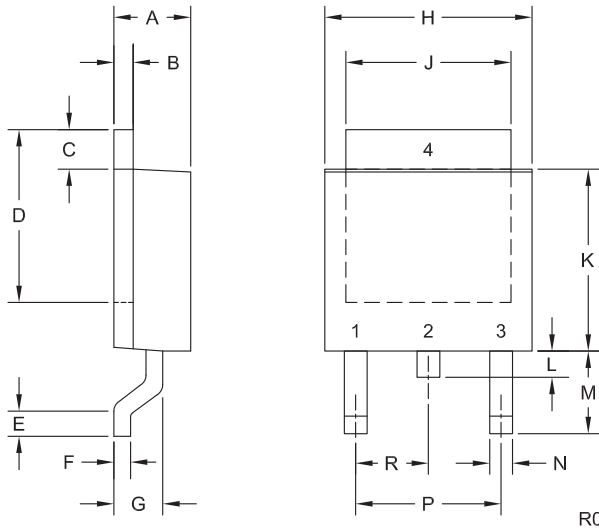


**ELECTRICAL CHARACTERISTICS - Continued:** ( $T_C=25^{\circ}\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	TYP	UNITS
$Q_{g(\text{tot})}$	$V_{DS}=640\text{V}, V_{GS}=10\text{V}, I_D=3.0\text{A}$ (Note 2)	11.3	nC
$Q_{gs}$	$V_{DS}=640\text{V}, V_{GS}=10\text{V}, I_D=3.0\text{A}$ (Note 2)	2.55	nC
$Q_{gd}$	$V_{DS}=640\text{V}, V_{GS}=10\text{V}, I_D=3.0\text{A}$ (Note 2)	5.28	nC
$t_{d(\text{on})}$	$V_{DD}=400\text{V}, I_D=3.0\text{A}, R_G=25\Omega$ (Note 2)	10	ns
$t_r$	$V_{DD}=400\text{V}, I_D=3.0\text{A}, R_G=25\Omega$ (Note 2)	23	ns
$t_{d(\text{off})}$	$V_{DD}=400\text{V}, I_D=3.0\text{A}, R_G=25\Omega$ (Note 2)	25	ns
$t_f$	$V_{DD}=400\text{V}, I_D=3.0\text{A}, R_G=25\Omega$ (Note 2)	25	ns
$t_{rr}$	$V_{GS}=0, I_S=3.0\text{A}, di/dt=100\text{A}/\mu\text{s}$ (Note 2)	437	ns
$Q_{rr}$	$V_{GS}=0, I_S=3.0\text{A}, di/dt=100\text{A}/\mu\text{s}$ (Note 2)	1.68	$\mu\text{C}$

Note 2: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

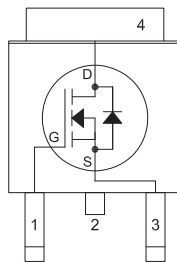
**DPAK CASE - MECHANICAL OUTLINE**



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.083	0.108	2.10	2.75
B	0.016	0.032	0.40	0.81
C	0.035	0.063	0.89	1.60
D	0.203	0.228	5.15	5.79
E	0.020	-	0.51	-
F	0.018	0.024	0.45	0.60
G	0.051	0.071	1.30	1.80
H	0.248	0.268	6.30	6.81
J	0.197	0.217	5.00	5.50
K	0.209	0.245	5.30	6.22
L	0.025	0.040	0.64	1.02
M	0.090	0.115	2.30	2.91
N	0.012	0.045	0.30	1.14
P	0.180		4.60	
R	0.090		2.30	

DPAK (REV: R0)

**PIN CONFIGURATION**



**LEAD CODE:**

- 1) Gate
- 2) Drain
- 3) Source
- 4) Drain

Pin 2 is common to the tab (4)

**MARKING: FULL PART NUMBER**

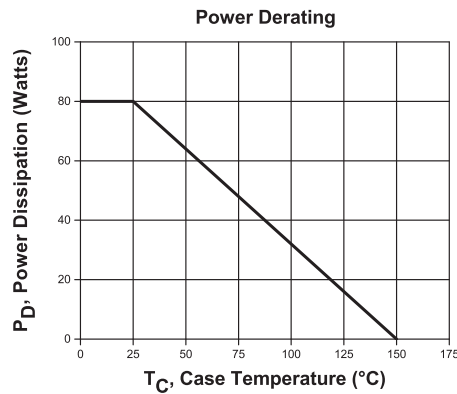
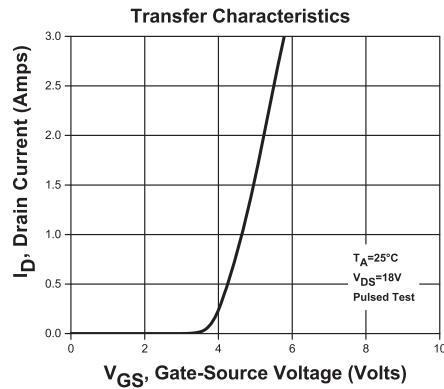
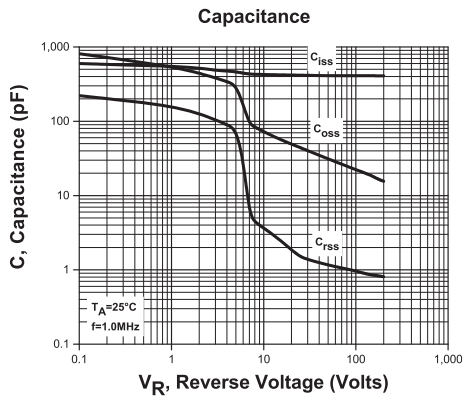
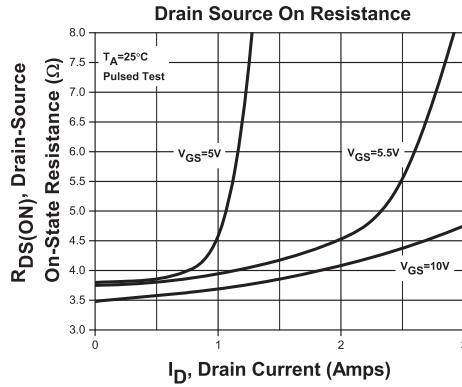
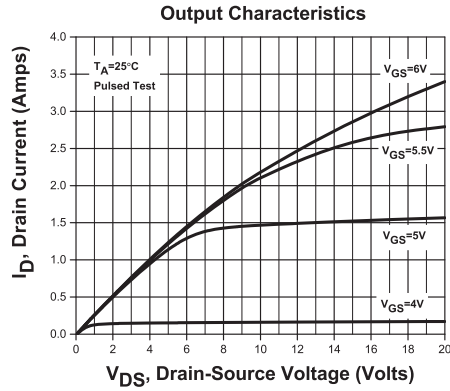
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TYPICAL ELECTRICAL CHARACTERISTICS



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2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

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### CONTACT US

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